5MHz to 6GHz Absorptive High Isolation SPDT Switch

Product Overview

The RFSW6024 is a Silicon on Insulator (SOI) Single-Pole Double Throw (SPDT) switch designed for uses in cellular, 3G, LTE and other high-performance communication systems. It offers a high isolation, symmetric throw ports with excellent linearity and power handling capability. No DC blocking capacitors are necessary on the RF ports. The design is non-reflective as such the RF port 1 or RF port 2 is terminated in the non-throw state. The VEN enable pin allows the switch entering the "All OFF State". The RFSW6024 is 1.8V positive logic compatible.



16 Pad 4 x 4 mm QFN Package

Key Features

- 5-6000 MHz Operation
- Symmetric SPDT
- Non-Reflective RF1 & RF2 Ports
- No Blocking Capacitors Necessary Unless DC Voltage on RF line
- High Isolation: 60 dB at 2 GHz
- High Input IP3: +66 dBm
- +1.8 V Logic Compatible

Functional Block Diagram



Applications

- Cellular, 3G, 4G, 5G Infrastructure
- WiBro, WiMax, LTE
- Wireless Backhaul
- High Performance Communication Systems
- Test Equipment

Ordering Information

Part No.	Description
RFSW6024TR13	2,500 pieces on a 13" reel (standard)
RFSW6024PCK-410	5 MHz – 6GHz Evaluation Board with 5-piece samples

RFSW6024 5 MHz to 6 GHz Absorptive High Isolation SPDT Switch

Absolute Maximum Ratings

Parameter	Rating
Storage Temperature	−40 to +150 °C
RF Input Power, CW, 50 Ω, T=25 °C	+36 dBm
Device Voltage (VDD)	+6 V
Control Voltage (VCTL, VEN)	+6 V

Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability.

Recommended Operating Conditions

Parameter	Min	Тур	Max	Units
Device Voltage (VDD)	+2.5	+3.0	+5.5	V
TCASE	-40		+105	°C
Tj for >10 ⁵ hours MTTF			+125	°C

Electrical specifications are measured at specified test conditions. Specifications are not guaranteed over all recommended operating conditions.

Electrical Specifications

Parameter	Conditions ⁽¹⁾	Min	Тур	Max	Units
Operational Frequency Range		5		6000	MHz
	0.3 GHz		0.55		dB
	1.0 GHz		0.60		dB
Insertion Loss ⁽²⁾	2.0 GHz		0.75	1.00	dB
(RFC to RF1/RF2)	3.0 GHz		0.90		dB
	4.0 GHz		0.90		dB
	5.0 GHz		1.10		dB
	0.3 GHz		75		dB
	1.0 GHz		63		dB
Isolation	2.0 GHz	53	60		dB
(RFC to RF1/RF2)	3.0 GHz		60		dB
	4.0 GHz		60		dB
	5.0 GHz		48		dB
	0.3 GHz		80		dB
	1.0 GHz		70		dB
Isolation	2.0 GHz	53	60		dB
(RF1 to RF2)	3.0 GHz		53		dB
	4.0 GHz		48		dB
	5.0 GHz		49		dB
	0.3 GHz		28		dB
	1.0 GHz		27		dB
Return Loss	2.0 GHz		20		dB
(RF1/RF2 ON-State)	3.0 GHz		20		dB
	4.0 GHz		22		dB
	5.0 GHz		17		dB
	0.3 GHz		37		dB
	1.0 GHz		36		dB
Return Loss	2.0 GHz		30		dB
(RF1/RF2 OFF-State)	3.0 GHz		27		dB
	4.0 GHz		23		dB
	5.0 GHz		20		dB

Electrical Specifications (Continued)

Parameter	Conditions ⁽¹⁾		Min	Тур	Max	Units
Operational Frequency Range			5		6000	MHz
Input ID2	1.0 GHz	+12 dBm input power per-tone,	55	65		dBm
Input IP3	2.0 GHz	1 MHz tone spacing	55	65		dBm
Input 0.1 dB Compression Power	1.0 GHz			36		dBm
Input 1 dB Compression Power	1.0 GHz			36		dBm
Setting Time	50% VCTL	50% VCTL to optimum functionality		1.5	3.0	μs
Start-up Time	90% VDD to full functionality			25	50	μs
Switching Time	50% contro	ol to 10/90% RF		250		ns
Switching Time	50% control to 2/98% RF			360	600	ns
Supply Current (IDD)	VDD 5.0V	VDD 5.0V		140	200	μA
Control Current, (I _{CTL} , I _{EN})	VCTL 5.0V	VCTL 5.0V		0.5	5.0	μA
Low Control Voltage (VCTL)	1.0.1/1.0.01				0.63	V
High Control Voltage (VCTL)		compatible	1.1		VDD	V

Notes:

1. Test conditions unless otherwise noted: VDD = +5.0 V, VCTL = 0/+5.0 V, Temp = +25 °C, 50 Ω system, RF ports DC Voltage 0V

2. PCB trace loss deducted

Maximum Operating Power at +85C, ≥300 MHz CW

Input Port	State	VEN	Power	Thermal Resistance, θ_{jc}
RFC, RF1 or RF2	ON	Low	33.0 dBm ⁽¹⁾	97 °C/W ⁽²⁾
RFC	Both OFF & RFC Reflective	High	31.3 dBm	N/A
RF1 or RF2	OFF & Terminated ⁽⁵⁾	Low or High	26.0 dBm	100 °C/W
RF1 and RF2	Both OFF & Terminated ⁽⁵⁾	High	27.8 dBm ⁽³⁾	65 °C/W

Notes:

1. Load VSWR ≤ 3:1; for higher load VSWR, the maximum Input power reduced to +30.5 dBm

2. Apply to resistive loss from the insertion loss not including mismatch loss

3. Total power on both RF1 and RF2 ports being driven simultaneously

4. For < 300 MHz, it is recommended to operate at least 4 dB below Input 1 dB Compression Power

5. Internally terminated

Truth Table

Control Input		Signal Path State		
VCTL	VEN	RFC ≒ RF1	RFC ≒ RF2	
0	0	OFF	ON	
1	0	ON	OFF	
0	1	OFF	OFF	
1	1	OFF	OFF	

Notes:

"0" = 0 V to 0.63 V; "1" = 1.1 V to VDD; VDD = 2.5 to 5.5 V must be applied for all valid states

5 MHz to 6 GHz Evaluation Board – RFSW6024PCK-410





Bill of Material – RFSW6024PCK-410

Value	Description	Manuf.	Part Number
-	Printed Circuit Board	Qorvo	RFSW6224-410(A)
-	SOI, High Isolation SPDT RF switch	Qorvo	RFSW6024
100 pF	CAP, 100 pF, 5%, 50V, C0G, 0402	Taiyo Yuden	RM UMK105 CG101JV-F
0 Ω	RES, 0 Ω, 50 Ω Max. Lead Free, 0402	KOA	RK73Z1ETTP
SMA	CONN, SMA, EL, Mini FLT 0.068", SPE-000303	Aliner	20-001CF-T
-	CONN, HDR, ST, PLRZD, 6-Pin, 0.100"	AMP	640454-6
	Value - - 100 pF 0 Ω SMA -	Value Description - Printed Circuit Board - SOI, High Isolation SPDT RF switch 100 pF CAP, 100 pF, 5%, 50V, COG, 0402 0 Ω RES, 0 Ω, 50 Ω Max. Lead Free, 0402 SMA CONN, SMA, EL, Mini FLT 0.068", SPE-000303 - CONN, HDR, ST, PLRZD, 6-Pin, 0.100"	Value Description Manuf. - Printed Circuit Board Qorvo - SOI, High Isolation SPDT RF switch Qorvo 100 pF CAP, 100 pF, 5%, 50V, COG, 0402 Taiyo Yuden 0 Ω RES, 0 Ω, 50 Ω Max. Lead Free, 0402 KOA SMA CONN, SMA, EL, Mini FLT 0.068", SPE-000303 Aliner - CONN, HDR, ST, PLRZD, 6-Pin, 0.100" AMP

Note:

1. Optional

RFSW6024 5 MHz to 6 GHz Absorptive High Isolation SPDT Switch

Performance Plots – RFSW6024PCK-410

Test conditions unless otherwise noted: VDD = +3.0 V, Temp.=+25 °C









Insertion Loss versus Input Power 25° C, V_{DD} = 5.5V





RFSW6024 5 MHz to 6 GHz Absorptive High Isolation SPDT Switch

Performance Plots – RFSW6024PCK-410 (Continued 1)

Test conditions unless otherwise noted: VDD = +3.0 V, Temp.=+25 °C



Isolation versus Frequency







Isolation During All Off State





RFSW6024 5 MHz to 6 GHz Absorptive High Isolation SPDT Switch

Performance Plots – RFSW6024PCK-410 (Continued 2)

Test conditions unless otherwise noted: VDD = +3.0 V, Temp.=+25 °C











IP3 versus Low Frequency 12dBm per Tone



P1dB versus Low Frequency



Switching Time Plots

Swithing Time (t_{OFF}) = 234ns, 50% VCTL to 10% RF, +85°C



Swithing Time (t_{OFF}) = 218ns, 50% VCTL to 10% RF, +25°C



Swithing Time (t_{OFF}) = 212ns, 50% VCTL to 10% RF, -40°C





Swithing Time (t_{ON}) = 286ns, 50% VCTL to 90% RF, +25°C



Swithing Time (t_{ON}) = 280ns, 50% VCTL to 90% RF, -40°C



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Pad Configuration and Description



Top View

Label	Description
VDD	DC Supply Voltage Input
VCTL	Logic Control Input, Logic High/Low sets the switch RFC-RF1/RF2 to "ON" state
RFC	RF Common Port, DC blocking capacitor required if > 0.5 V external voltage is present
NC	No Internal Connection, External connection to PCB Ground Recommended to maximize isolation
VEN	Logic Control Input, Logic High sets the switch both RF1 and RF2 to "OFF" state
NC	Ground or No Connection, External connection to PCB Ground Recommended to maximize isolation
RF1	RF Port 1, DC blocking capacitor required if > 0.5 V external voltage is present
RF2	RF Port 2, DC blocking capacitor required if > 0.5 V external voltage is present
GND	RF and DC ground. Must be soldered on PCB ground plane over a bed of via holes to minimize inductance and thermal resistance
	Label VDD VCTL RFC NC VEN NC RF1 RF2 GND

RFSW6024 5 MHz to 6 GHz Absorptive High Isolation SPDT Switch

Package Marking and Dimensions

Marking: Part Number - SW6024

Trace Code – Assigned by subcontractor



Notes:

- 1. All dimensions are in millimeters. Angles are in degrees.
- 2. The terminal #1 identifier and terminal numbering conform to JESD 95-1 SPP-012.
- 3. Contact plating: NiPdAu



PCB Mounting Pattern

Notes:

- 1. All dimensions are in millimeters. Angles are in degrees.
- 2. Use 1 oz. copper minimum for top and bottom layer metal.
- 3. Via holes are required under the backside paddle of this device for proper RF/DC grounding and thermal dissipation. We recommend a 0.35mm (#80/.0135") diameter bit for drilling via holes and a final plated thru diameter of 0.25 mm (0.01").
- 4. Ensure good package backside paddle solder attach for reliable operation and best electrical performance.

Tape and Reel Information – Carrier and Cover Tape Dimensions



Feature	Measure	Symbol	Size (in)	Size (mm)
	Length	A0	0.169	4.30
Covity	Width	B0	0.169	4.30
Cavity	Depth	K0	0.049	1.25
	Pitch	P1	0.315	8.00
Contorlino Distance	Cavity to Perforation - Length Direction	P2	0.079	2.00
Centerline Distance	Cavity to Perforation - Width Direction	F	0.217	5.50
Cover Tape	Width (Reference Only)	С	0.362	9.20
Carrier Tape	Width	W	0.472	12.0

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Tape and Reel Information – Reel Dimensions

Standard T/R size = 2,500 pieces on a 13" reel.



Feature	Measure	Symbol	Size (in)	Size (mm)
Flange	Diameter	A	12.992	330.0
	Thickness	W2	0.717	18.2
	Space Between Flange	W1	0.504	12.8
Hub	Outer Diameter	N	4.016	102.0
	Arbor Hole Diameter	С	0.512	13.0
	Key Slit Width	В	0.079	2.0
	Key Slit Diameter	D	0.787	20.0

Tape and Reel Information – Tape Length and Label Placement



Notes:

1. Empty part cavities at the trailing and leading ends are sealed with cover tape. See EIA 481-1-A.

2. Labels are placed on the flange opposite the sprockets in the carrier tape.



Handling Precautions

Parameter	Rating	Standard	
ESD-Human Body Model (HBM)	Class 2	ESDA/JEDEC JS-001-2012	Caution!
ESD-Charged Device Model (CDM)	Class C3	JEDEC JESD22-C101F	ESD-Sensitive Device
MSL-Moisture Sensitivity Level	Level 1	IPC/JEDEC J-STD-020	

Solderability

Compatible with both lead-free (260°C max. reflow temp.) and tin/lead (245°C max. reflow temp.) soldering processes. Solder profiles available upon request.

Contact plating: NiPdAu

RoHS Compliance

This part is compliant with 2011/65/EU RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment) as amended by Directive 2015/863/EU.

This product also has the following attributes:

- Lead Free
- Halogen Free (Chlorine, Bromine)
- Antimony Free
- TBBP-A (C₁₅H₁₂Br₄0₂) Free
- SVHC Free
- PFOS Free

Contact Information

For the latest specifications, additional product information, worldwide sales and distribution locations:

Web: <u>www.qorvo.com</u>

Tel: 1-844-890-8163

Email: customer.support@gorvo.com

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